

### **N-Channel 80V MOSFET**

#### E080N8P7CH1

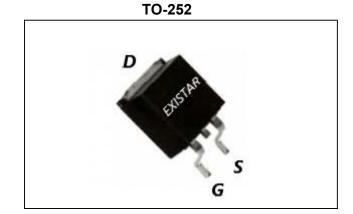
V <sub>DS</sub> (V)	$R_{DS(on),max}$ (m $\Omega$ )	I <sub>D</sub> (A)
80V	8.7 @ V <sub>GS</sub> = 10V	80

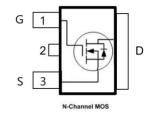
#### **Features**

- Low R<sub>DS(on)</sub> trench technology
- Low thermal impedance
- Fast switching speed
- 100% avalanche tested

## **Applications**

- DC/DC conversion
- Power switch
- PD charger
- Moto driver







# **Package And Ordering Information**

Ordering code	Package	Marking
E080N8P7CH1	TO-252	E080N8P7CH1

**Ordering Information** 

Package	Units/ Reel	Reels/ Inner Box	Units/ Inner Box
TO-252	2500	1	2500



**Key Performance Parameters** 

Parameter	Value	Unit
VDS, min @ Tj(max)	80	V
ID, pulse	324	А
RDS(ON), max @ VGS=10V	8.7	mΩ
Qg	112	nC

Absolute Maximum Ratings at Tj=25°C Unless Otherwise Noted

Parameter	Symbol	Limit	Unit	
Drain-source voltage	V <sub>DS</sub>	80		
Gate-source voltage			±20	V
	Tc=25°C		80	
Continuous drain current	T <sub>C</sub> =100°C	- I <sub>D</sub>	51	
Pulsed drain current	I <sub>D,pulse</sub>	324	А	
Avalanche energy, single pulse		E <sub>AS</sub>	361	mJ
Dower discipation	Tc=25°C		125	
Power dissipation	T <sub>C</sub> =100°C	$P_{D}$	50	W
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>stg</sub>	-55 To 150	°C	

### **Thermal Characteristics**

Parameter		Symbol	Max.	Uni t
Thermal resistance, junction-to-case	Steady state	$R_{ heta JC}$	1	
Thermal resistance, junction-to-ambient	Steady state	Reja	-	°C/W

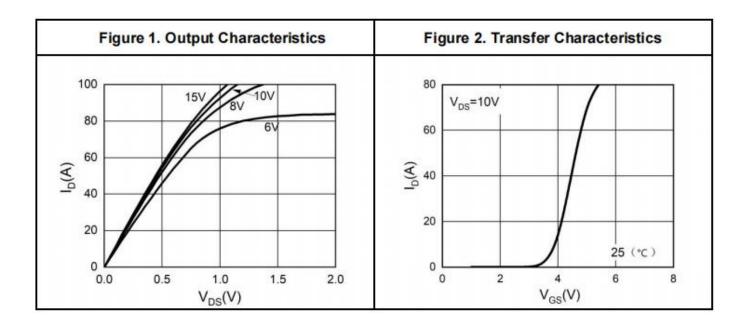
Electrical Characteristics at Tj=25°C unless otherwise specified

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test conditions	
Static							
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	80			V	V <sub>GS</sub> = 0, I <sub>D</sub> = 250 μA	
Gate-source threshold voltage	V <sub>G</sub> s(th)	2	2.8	4	V	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	
Gate-body leakage	I <sub>GSS</sub>			±100	nA	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ±20 V	
Zero gate voltage drain current	I <sub>DSS</sub>			1	μA	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V	
Drain-source on-resistance	D ()		7.5	8.7	mΩ	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 40 A	
	R <sub>DS</sub> (on)		9	11.2	mΩ	V <sub>GS</sub> = 6 V, I <sub>D</sub> = 20 A	
Forward transconductance	gfs		36		S	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 40 A	

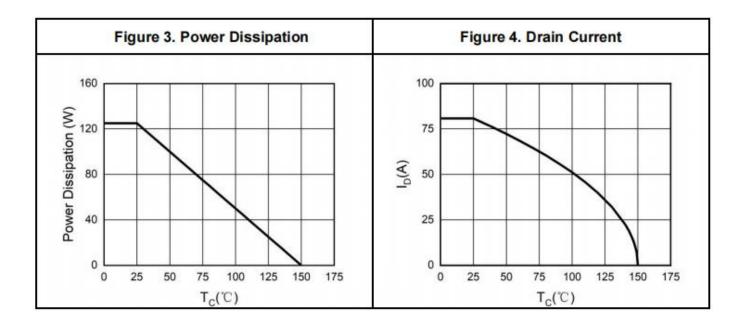


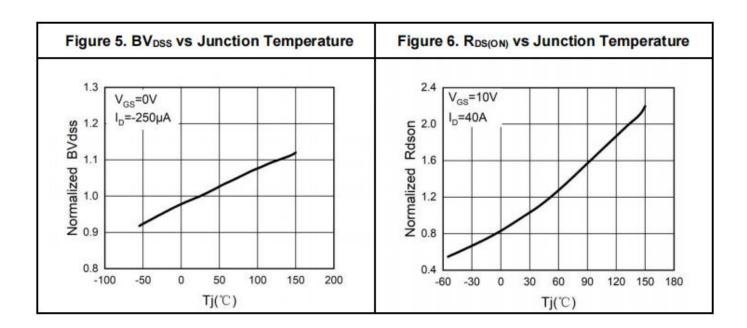
Gate resistance	Rg		0.65		Ω	f=1MHz		
Gate Charge								
Total gate charge	Qg		112					
Gate-source charge	Qgs		15		nC	V <sub>DS</sub> = 40 V, I <sub>D</sub> = 20 A, V <sub>GS</sub> = 10 V		
Gate-drain charge	Qgd		45					
	Dynamic							
Turn-on delay time	t <sub>d(on)</sub>		30					
Rise time	tr		18			V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 10 V,		
Turn-off delay time	t <sub>d(off)</sub>		65			$R_L = 2 \Omega$ , $R_{GEN} = 6 \Omega$		
Fall time	t <sub>f</sub>		30		ns			
Input capacitance	C <sub>iss</sub>		4400					
Output capacitance	C <sub>oss</sub>		197			V <sub>DS</sub> =40 V, V <sub>GS</sub> = 0 V, f = 1.0MHz		
Reverse transfer capacitance	C <sub>rss</sub>		171		pF			
Body Diode								
Diode forward voltage	V <sub>SD</sub>			1.2	V	V <sub>GS</sub> = 0 V, I <sub>F</sub> = 20 A		
Reverse recovery time	t <sub>rr</sub>		7		ns nC	1 00 A 11/11 400 A/		
Reverse recovery charge	Qrr		40			I <sub>S</sub> =20 A, di/dt = 100 A/μs		

# **Electrical Characteristics Diagrams**

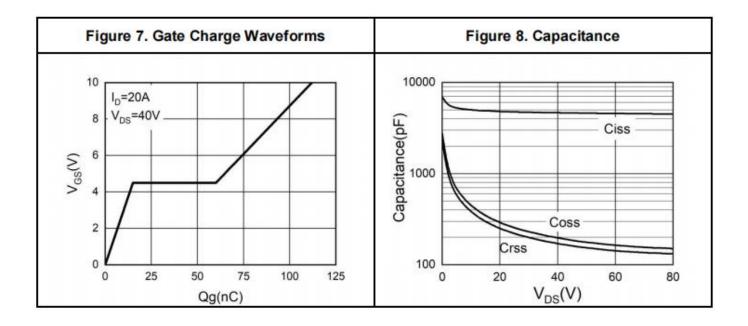


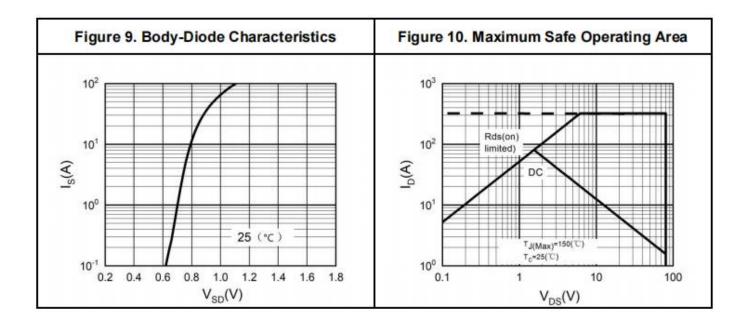






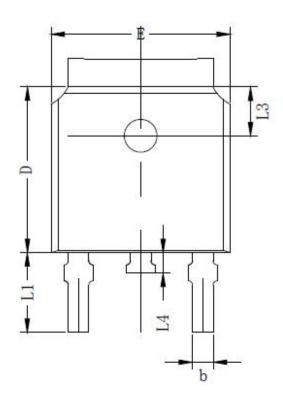


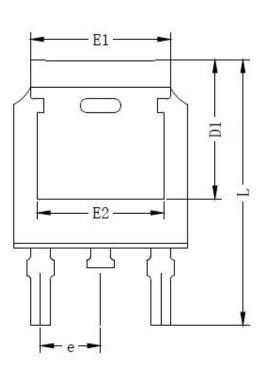






# **Package Outline Dimensions**





SYMBOL	MIN	NDM	MAX		
Α	2.10	2,30	2.50		
A1	0,97	1.07	1.17		
A2	0.00	) <del>1202</del> )	0.12		
b	0.66	0.76	0.86		
С	0.45	0.51	0.60		
D	5.90	6.10	6,30		
D1	5.10	5.30	5,45		
E	6.40	6.60	6.80		
E1	5.10	5.33	5.45		
E2	4.63	4.83	5.03		
L	9,90	10.10	10.30		
L1	2.74	2.94	3.14		
L2	1.40	1.50	1.70		
L3	1.65	1.80	1.95		
L4	0,60	0,80	1.00		
е	2.286BSC				
θ	5°	7°	10°		
θ 1	0°	<del>(40</del> )	3°		



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